TI's Lead (Pb)-Free and Green Program

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May 25, 2004



- Participates in industry standards organizations and works with legislative groups to set achievable and meaningful environmental goals
- Began removing Lead (Pb) from products more than a decade ago
 - Over 70% of TI's leadframe components do not contain lead and are compatible with proposed RoHS thresholds



- All TI Logic products are available Pb-Free
- Is actively qualifying Pb-Free and Green solutions that go beyond current industry thresholds in anticipation of future environmental requirements
- By the end of 2004, >95% of TI products will be available Lead (Pb)-Free and Green





RoHS compatible + high temp =

 Lead (Pb)-Free: TI defines "Lead (Pb)-Free" or "Pb-Free" to mean RoHS compatible, including a lead concentration that does not exceed 0.1% of total product weight, and, if designed to be soldered, suitable for use in specified leadfree soldering processes.



• **Green:** TI defines "**Green**" to mean Lead (Pb)-Free and, in addition, uses package materials that do not contain halogens, including bromine (Br), or antimony (Sb) above 0.1% of total product weight.





Customers recognize TI's nickel-palladium-gold (NiPdAu) as the best lead finish available

- TI's primary Pb-Free finish is NiPdAu
 - No other supplier offers as comprehensive a selection of products in NiPdAu



- Fully compatible with Pb and Pb-Free soldering processes
- By end of 2004, >95% of TI leadframe products will be converted to NiPdAu and Green
- TI will offer separate Pb and Pb-Free Array package versions
 - Array package solder balls can not be made to be compatible with both Pb and Pb-Free solder processes
 - Pb-Free versions will have new industry standard tin-silver-copper (SnAgCu) solder balls
 - TI will continue to offer older Pb solder ball versions as long as customers need them



- Product part numbers will not change as long as part is 100% backward compatible with Pb-based solder processes
- Since Ball Array products are not backward compatible, a new Pb-Free version will be offered with a new part number



- Pb versions of Array products will continue to be offered
- A "Pb-Free Part Number" may be created if this is required to insure supply of Pb-Free products for specific customer projects
 - The "Pb-Free Part Number" will be in addition to the current product part number



🤴 Texas Instruments



A 2-character suffix aligned with JEDEC E-Cat nomenclature will be added.

Example: Standard Part Number: TPS75701KTTR

New "Pb-Free Part Number":

TPS75701KTTRG4

Category	Description
	Not Lead (Pb)-Free. No ECAT
е	Pb-Free. Not Green rated
e1	SnAgCu (shall not be included in category e2
e2	Sn alloys with no Bi or Zn excluding SnAgCu
e3	Sn
e4	Preplated (e.g., Ag, Au, NiPd, NiPdAu)
e5	SnZn, SnZnx (no Bi)
e6	Contains Bi
e7	Low temperature solder (<150C) containing In (no Bi)
G	Pb-Free. Green rated.
G1	Green rated. SnAgCu
G2	Green rated. Sn alloys with no Bi or Zn excluding SnAgCu
G3	Green rated. Sn
G4	Green rated. Preplated (e.g., Ag, Au, NiPd, NiPdAu)
G5	Green rated. SnZn, SnZnx (no Bi)
G6	Green rated. Contains Bi





	Pb-Containing Designator	Pb-Free Designator
Array Packages		
Ball Grid Packages	Gab	Zab
Bumped Die Sales	YE	YZ
►NanoStar	YEx	Yzx

Examples:	
Pb Version	TMS320VC5509AGHH
Pb- Free Version	TMS320VC5509A <mark>Z</mark> HH
Pb Version	SN74LVC1G86Y <mark>E</mark> AR
Pb-Free Version	SN74LVC1G86Y <mark>Z</mark> AR

New designators will be assigned and released as required. Contact your Sale Representative for additional information.

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External Website: General Features

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	Product Content Materials of Concern	Disclaimer	- Corporate Information	
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	General Information	Perform a search by "TI Part Number" OR "Customer Part Number".		
	Lead (Pb)-Free	TI Part Number Customer Part Number		
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		Multiple Part Number Search		
		Perform a search by "TI Part Number" AND/OR "Customer Part Number". Please enter an exact part number . Partial part numbers are not supported. One device per line with no extra characters. Limit of 1000 Devices per Search.		
		TI Part Number Customer Part Number		
		AND/ OR		
		Display 200 Results Per Page Search Disclaimer The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better inti- information from third parties. TI has taken and continues to take reasonable steps to provide	2	

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External Website: Search Features

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detailed	Part Number	Assembly Site	Current	(Pb)-Free Orderable	RoHS Compatible	Green Orderable	Package Type Pins		
information.	TPS62000DGSR	Ext-Mfg		N	N	N	DGS 10		
	TPS62000DGSR	Ext-Mfg		N	N	N	DGS 10		
							Back to Top		
	Definitions								
	Ext-Mfg: means a	a location operate	d by a thir	d party und	ler contract v	vith TI.			
		'Y' indicates that iy (Sb), in additior					icluding Bromine 9b)-Free, If blank,		
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	lead concentration	n that does not ex or use in specified	ceed 0.19	% of total p	roduct weigh	t, and, if d	esigned to be		
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Pb-Free

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External Website: Look-up Results

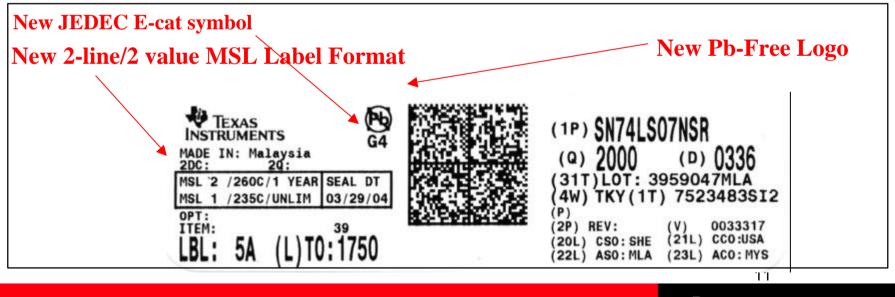
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			Conversion Date		Green Orderable	N			
	Detailed Pb-Free and	RoHS Compatib Package Body S	de Size (W × L × H)	N 3.00X3.00X1.02	Green Conversion Date Package Total Mass (g)	0.0204			
	Green estimated plan	mm	,						
	dates plus					Back to 1	бор		
	Component	Planned Lead (Pb)-Free Changes -	Estimated Dates					
	Information about:		PCN Release Date		Lead(Pb)-Free Initial Supply [Date 15-Jun-2004			
		Lead(Pb)-Free	Assured Supply Date	12-Dec-2004	Lead(Pb)-Free Finish	NiPdAu			
	Bond Wire					Back to 1	ор		
	Die Attach Adhesive	Planned Green	Changes - Estimate	d Dates					
	Lead Frame Green PCN Release Date 17-Mar-2004 Green Initial Supply Date 15-Jun-2004 Green Assured Supply Date 12-Dec-2004								
	Mold Compound					Back to 1	ор		
	Semiconductor	Component Inf	ormation						
	Device				Amount of P	ercentage			

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- "Pb-Free logo" on packing labels in 2003
 - Parts that utilize a Pb-Free finish and are rated for high-temp reflow (250C/260C)
 - Pb-Free parts also carry two level MSL rating information
- JEDEC E-Cat symbols will be incorporated in June 2004
- Pb-Free information contained in 2D barcode







For questions, vendor surveys or conversion status information, use our Pb-Free and Green resources:

TI Web site <u>www.ti.com/leadfree</u>

Easy-to-use search engine to determine Pb-Free status and schedule for all TI products

• Your TI sales representative

• <u>ezsurveys@list.ti.com</u>

Best resource for questionaires, vendor surveys or for requesting conversion status and material content on long lists of part numbers

